Guidelines of Wah Lee Scholarship for Students of College of Engineering, National Sun Yat-Sen University

Stipulated on April 22, 2016 in the college's 8th Chairs Meeting for the 2015 academic year. Amended on June 7, 2018 in the college's 10th Chairs Meeting for the 2017 academic year. Amended on May 5, 2022 in the college's 5th Chairs Meeting for the 2021 academic year.

1. Purpose of the Scholarship:

The Wah Lee Industrial Corp. has established the "Wah Lee Scholarship for Students of College of Engineering, National Sun Yat-Sen University" with the goal of fulfilling corporate social responsibility, cultivating high-level engineering talents, and rewarding outstanding students.

2. Applicant Eligibility:

- A full-time Ph.D. student at the College of Engineering (hereinafter referred to as "the College") of the University.
- Academic grades are 80 and above (or equivalent) in each subject in the previous semester.
- Not receiving any other scholarships in the year before the application deadline. (except for the admission scholarships for elite doctoral students and scholarships that require labor obligations)
- Majoring in the following fields:
 - A. Energy and energy storage materials: high-performance lithium-ion batteries (positive and negative electrode materials, separators), fuel cells, super capacitors, and other energy-storage materials.
 - B. High-frequency communication materials: Low Dk/Df, high thermal conductivity materials.
 - C. Electronic packaging materials
 - D. <u>Composite materials</u>

3. Application period:

The application period starts from the opening day of the first semester until October 15. The application period will be announced in advance by the College.

4. Number of Recipients and Amount of Prize:

A maximum of <u>two students</u> will be awarded the scholarship each year, with each student receiving <u>NT\$200,000</u> (which will be distributed in two semesters).

5. Application process:

Eligible applicants are required to submit the following documents and apply to the College during the application period:

- (1) Application form
- (2) Original copy of past academic transcripts (grade reports)

- (3) Recommendation letter from supervisor
- (4) Autobiography essay
- (5) Publications in domestic and foreign journals and conferences, or other documents or reports which meet the review criterion (submitted in PDF format)

6. Review process:

(1) First-stage preliminary review (written review):

Delegates from Wah Lee Group will first review the documents submitted by applicants.

(2) Second-stage review:

Delegates from Wah Lee Group will be invited to attend the College's Chairs Meeting for joint evaluation.

7. The guidelines are implemented after being stipulated or amended by the College's Chairs Meeting. The scholarship donor representative can request for further revisions on an annual basis if necessary.

Application Form of Wah Lee Scholarship College of Engineering National Sun Yat-sen University

Application Date : yyyy/mm/dd Dept. Grade Ph.D. Grade Name Phone (or Student ID extension Email number) Address ID No. Post Office Post Office Number: Account Number (The account name must be the student himself/herself) A full-time Ph.D. student at the College of Engineering of the University. * Ph.D. freshmen should attach the transcripts of all academic years of their master's. Academic grades are 80 and above (or equivalent) in each subject in the previous semester. Not receiving any other scholarships in the year before the application deadline. (except for the admission scholarships for elite doctoral students and scholarships that require labor obligations). Qualification Majoring in the following fields: (please pick at least one) Energy/ Energy storage materials: high-performance lithium-ion batteries (positive and negative electrode materials, separators), fuel cells, super capacitors, and energy storage related High-frequency communication materials: Low Dk/Df, high thermal conductivity materials Electronic packaging materials Composite materials Previous **Research** Topics Engaged International Journal: article(s) (SCIE article(s); SSIC article(s); EI article(s)) International Conference: article(s) (Oral article(s); Poster article(s); Others article(s)) Academic Domestic Journal: article(s) Performance (SCIE article(s); SSIC article(s); EI article(s)) (Including Domestic Conference: article(s) accepted but (Oral article(s); Poster article(s); Others article(s)) unpublished Ministry of Science and Technology Project : _____ piece(s) journal articles) Patent : _____piece(s) Technology Transfer : _____piece(s) (submitted in PDF)

Awards (up to 5 items)			
Other favorable deeds for review			
Applicant Signature	Supervisor's Signature	Department Head's Signature	

*The applicant hereby declares that the above information and attachments are true. If there is any false information, the applicant is willing to take legal responsibility and return the scholarship.